

LOW-DIMENSIONAL SYSTEMS
AND SURFACE PHYSICS

**Effect of the Chromium Layer Thickness on the Morphology
and Optical Properties of Heterostructures
Si(111)/(CrSi₂ Nanocrystallites)/Si(111)**

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Abstract—Growth and the optical properties of epitaxial heterostructures Si(111)/(CrSi₂ nanocrystallites)/Si(111) based on nanosized islands of chromium disilicide (CrSi₂) on Si(111) were studied using low-energy electron diffraction, atomic-force microscopy, and optical reflection and transmission spectroscopy. The heterostructures with thicknesses of 0.1, 0.3, 0.6, 1.0, and 1.5 nm were formed by reactive epitaxy at a temperature of 500°C followed by the epitaxial growth of silicon at 750°C. The specific features of changes in the density and sizes of CrSi₂ islands on the silicon surface were determined at $T = 750^\circ\text{C}$ as the chromium layer thickness was increased. It was established that, in the heterostructures with chromium layer thicknesses exceeding 0.6 nm, a small part of faceted Cr₂Si₂ nanocrystallites (NCs) emerge into near-surface region of the silicon, which is confirmed by the data from optical reflectance spectroscopy and an analysis of the spectral dependence of the absorption coefficient. A critical size of NCs is shown to exist above which their shift to the silicon surface is hampered. The decreased density of emerging NCs at chromium layer thicknesses of 1.0–1.5 nm is associated with the formation of coarser NCs within a silicon layer, which is confirmed by the data from differential reflection spectroscopy.

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1. INTRODUCTION

Chromium disilicide (CrSi₂) is a narrow-gap (0.35 eV) semiconductor in accordance with theoretical calculations [1–3] and experimental data [4, 5]. It is known that, on silicon with (111) orientation, epitaxial CrSi₂ films grow [4–7]. Plusnin et al. [5] proposed a technique for separating a preferred orientation in CrSi₂ films. This technique made it possible to grow continuous epitaxial A-type CrSi₂(0001) films on Si(111) [6, 7]. In such layers, noticeable changes in the electronic structure and in the carrier scattering mechanism have been revealed and a significant increase in the mobility of majority carriers (holes) and a decrease in their concentration have been observed. These changes were related to elastic stresses that occur during epitaxial growth of A-type CrSi₂(0001) films with 30° rotation relative to the silicon lattice and with a crystal lattice misfit between Si(111) and CrSi₂(0001) of the order of 0.1%. The presence in A-type epitaxial CrSi₂(0001) films of a certain amount of the B-type CrSi₂(0001) phase with orientation coinciding with that of the Si(111) silicon substrate makes it impossible to grow single-crystal CrSi₂(0001) films and produce binary heteroepitaxial structures Si(111)/CrSi₂(0001)/Si(111). Such structures are of interest for silicon microelec-

tronics and optoelectronics as photoelectrical transducers and heterostructure transistors. However, instead of continuous epitaxial CrSi₂(0001) films, island CrSi₂ films can be used with island sizes of several tens of nanometers. This approach can be used to prepare silicon with an embedded layer or layers of CrSi₂ nanocrystallites (NCs), which can be elastically adjusted to the silicon lattice parameters, creating a high density of CrSi₂ NCs/Si heterojunctions [8]. At a CrSi₂ NC density higher than 10^{10} cm^{-2} , hopping conduction can occur between the nanocrystallites, and this conduction will depend on the properties and defect structure of the CrSi₂ NCs/Si interface. This behavior of the conductivity should lead to changes in the electrical and optical properties of the heteroepitaxial structures Si(111)/CrSi₂ NCs/Si(111) and can also be used to design new types of apparatus structures.

In [9], we established that, upon reactive deposition of chromium on an atomically pure Si(111) 7×7 surface at 500°C followed by epitaxial silicon growth, monolithic Si(111)/CrSi₂(0001) NCs/Si(111) heterostructures are formed; we also grew multilayer (2- to 6-layer) monolithic heterostructures with a silicon-layer thickness of 36 nm. However, the effect of the chromium layer thickness on the formation of nanosized